# Special Issue Smart Systems (SmaSys2021)

#### Message from the Guest Editors

We are planning to publish a Special Issue on "Smart Systems" related to the International Conference of Smart Systems Engineering (SmaSys2021, http://smasys.yz.yamagata-u.ac.jp/2021/) held on 7-8 October 2021 in Yonezawa, Japan. This Special Issue provides opportunities for collaboration across a wide range of fields and technologies related to emerging smart systems. Smart systems regard broad scientific and engineering fields. They include organic materials, organic electronics, organic devices, biomaterials, biomedical and biosystem engineering, electrical engineering and informatics, mechanical systems engineering, smart flexible structures and systems, green materials and their processing, tourism engineering with agriculture and foods, and new engineering education. All the participants of SmaSys2021 and their colleagues—especially students are encouraged to submit their works to this Special Issue.

#### **Guest Editors**

Prof. Dr. Bungo Ochiai

Prof. Dr. Go Matsuba

Prof. Dr. Tomoya Higashihara

Dr. Sathish K. Sukumaran

Dr. Kohei Osawa

#### Deadline for manuscript submissions

closed (31 March 2022)



## **Technologies**

an Open Access Journal by MDPI

Impact Factor 3.6 CiteScore 8.5



mdpi.com/si/90494

Technologies
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
technologies@mdpi.com

mdpi.com/journal/technologies





## **Technologies**

an Open Access Journal by MDPI

Impact Factor 3.6 CiteScore 8.5



### About the Journal

#### Message from the Editor-in-Chief

Technologies, provides a single focus for reporting on developments of all technologies, regardless of their application. It is our intention that Technologies becomes the journal of choice for both researchers wanting to publish their work and technologists wishing to exploit the high quality research across a wide range of potential applications. Through its open access policy, its quick publication cycle, Technologies will facilitate the rapid uptake and development of the research presented, ultimately providing benefit to the wider society.

#### Editor-in-Chief

Prof. Dr. Manoj Gupta

Department of Mechanical Engineering, National University of Singapore, Singapore 117576, Singapore

#### **Author Benefits**

#### **High Visibility:**

indexed within ESCI (Web of Science), Scopus, Inspec, Ei Compendex, INSPIRE, and other databases.

#### Journal Rank:

JCR - Q1 (Engineering, Multidisciplinary) / CiteScore - Q1 (Computer Science (miscellaneous))

#### **Rapid Publication:**

manuscripts are peer-reviewed and a first decision is provided to authors approximately 21.8 days after submission; acceptance to publication is undertaken in 3.9 days (median values for papers published in this journal in the first half of 2025).

